# 6-2149979-3 ACTIVE

#### **IMPACT**

TE Internal #: 6-2149979-3

High Speed Backplane Connectors, 72 Position, Mating Alignment, Keyed Mating Alignment Type, 12 Row, 6 Column, PCB Mount Header, Vertical, IMPACT

View on TE.com >



Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Number of Positions: 72

Row-to-Row Spacing: 1.35 mm [ .053 in ]

Mating Alignment: With

Mating Alignment Type: Keyed

Number of Rows: 12

### **Features**

### **Product Type Features**

Signal Arrangement

Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Fully Shrouded
Configuration Features	
Number of Ground Positions	24
Number of Pairs	24
Stackable	No
Number of Signal Positions	48
Number of Positions	72
Number of Rows	12
Number of Columns	6
PCB Mount Orientation	Vertical
Guide Location	Right
Electrical Characteristics	
Impedance	100 Ω

Differential

30 VAC

Operating Voltage



## Signal Characteristics

Rody Features	
Data Rate	20 – 25 Gb/s
Number of Differential Pairs per Column	4

#### **Body Features**

Drives and Dreamber of Callana	DII-	
Primary Product Color	Black	

### **Contact Features**

Contact Mating Area Length	5.5 mm[.217 in]
PCB Contact Termination Area Plating Material Thickness	.76 – 1.52 μm[30 – 60 μin]
Contact Layout	Inline
Contact Type	Pin
Contact Underplating Material Thickness	1.27 μm[50 μin]
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
Contact Mating Area Plating Material	Gold
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Dual Beam
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	.75 A

### **Termination Features**

Termination Post & Tail Length	1.4 mm[.055 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

### Mechanical Attachment

PCB Mount Alignment Type	Locating Posts
Guide Hardware	With
Mating Retention	Without
PCB Mount Retention	With
PCB Mount Retention Type	Action/Compliant Tail
Mating Alignment	With
Mating Alignment Type	Keyed
Connector Mounting Type	Board Mount

## Housing Features



Number of Shrouded Sides	3
End Wall Location	Right
Housing Material	LCP (Liquid Crystal Polymer)
Centerline (Pitch)	1.9 mm[.075 in]
Dimensions	
Connector Length	19.3 mm[.76 in]
Connector Height	11.95 mm[.47 in]
Connector Width	20.8 mm[.819 in]
PCB Thickness (Recommended)	1 mm[.039 in]
PCB Hole Diameter	.39 mm[.015 in]
Row-to-Row Spacing	1.35 mm[.053 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Compatible With Approved Standards Products	CSA Certified, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tube, Tube

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free



### Solder Process Capability

Not applicable for solder process capability

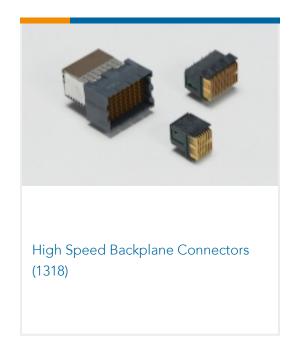
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**



## Also in the Series | IMPACT



## **Customers Also Bought**















### **Documents**

## **Product Drawings**

IMP100,S,H,V4P6C,LG,REW39

English

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_6-2149979-3\_A.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_6-2149979-3\_A.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_6-2149979-3\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## **Product Specifications**

**Application Specification** 

English

### Agency Approvals

Agency Approval Document

English